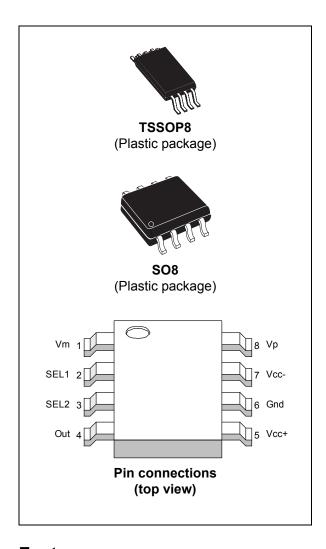


### High-voltage, high-side current sense amplifier

Datasheet - production data



#### **Features**

- Independent supply and input common-mode voltages
- Wide common-mode operating range:
   2.9 V to 70 V in single-supply configuration,
   -2.1 V to 65 V in dual-supply configuration
- Wide common-mode surviving range:

   16 V to 75 V (reversed battery and load-dump conditions)

- Supply voltage range:
  2.7 to 5.5 V in single-supply configuration
- Low current consumption: I<sub>CC</sub> max = 360 μA
- Pin selectable gain: 20 V/V, 25 V/V, 50 V/V or 100 V/V
- Buffered output

#### **Applications**

- · Automotive current monitoring
- DC motor control
- Photo-voltaic systems
- · Battery chargers
- Precision current sources
- Current monitoring of notebook computers
- Uninterruptible power supplies
- High-end power supplies

### **Description**

The TSC103 measures a small differential voltage on a high-side shunt resistor and translates it into a ground-referenced output voltage. The gain is adjustable to four different values from 20 V/V up to 100 V/V by two selection pins.

Wide input common-mode voltage range, low quiescent current, and tiny TSSOP8 packaging enable use in a wide variety of applications.

The input common-mode and power-supply voltages are independent. The common-mode voltage can range from 2.9 V to 70 V in the single-supply configuration or be offset by an adjustable voltage supplied on the Vcc- pin in the dual-supply configuration.

With a current consumption lower than 360  $\mu A$  and a virtually null input leakage current in standby mode, the power consumption in the applications is minimized.

Contents TSC103

# **Contents**

1	App	lication schematic and pin description 3						
2	Abso	Absolute maximum ratings and operating conditions 6						
3	Elec	trical characteristics						
4	Elec	trical characteristics curves: current sense amplifier 10						
5	Para	meter definitions						
	5.1	Common-mode rejection ratio (CMR)						
	5.2	Supply voltage rejection ratio (SVR)						
	5.3	Gain (Av) and input offset voltage (V <sub>os</sub> )						
	5.4	Output voltage drift versus temperature						
	5.5	Input offset drift versus temperature						
	5.6	Output voltage accuracy						
6	Maxi	mum permissible voltages on pins						
7	App	lication information						
8	Pack	kage information						
	8.1	TSSOP8 package information						
	8.2	SO8 package information						
9	Orde	ering information						
10	Revi	sion history						



## 1 Application schematic and pin description

The TSC103 high-side current sense amplifier can be used in either single- or dual-supply mode. In the single-supply configuration, the TSC103 features a wide 2.9 V to 70 V input common-mode range totally independent of the supply voltage. In the dual-supply range, the common-mode range is shifted by the value of the negative voltage applied on the Vcc-pin. For instance, with Vcc+ = 5 V and Vcc- = -5 V, then the input common-mode range is -2.1 V to 65 V.

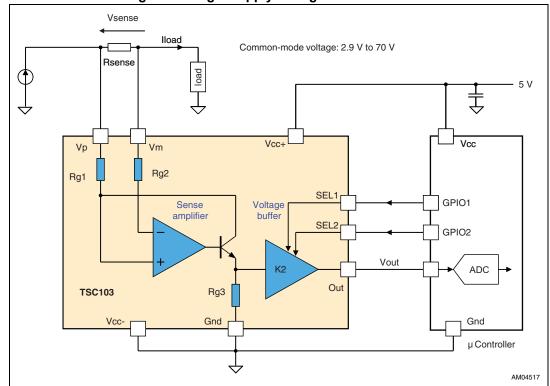


Figure 1. Single-supply configuration schematic

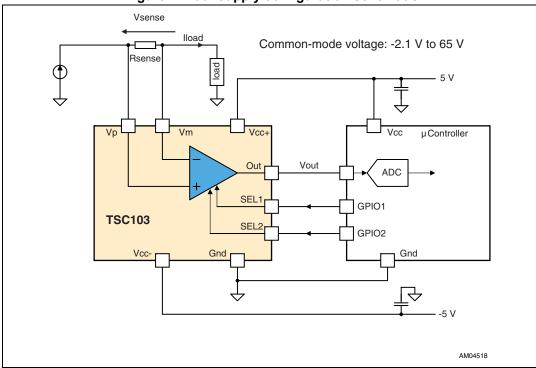
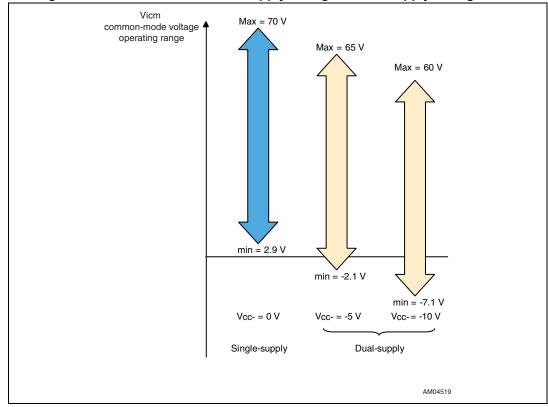


Figure 2. Dual-supply configuration schematic





577

*Table 1* describes the function of each pin. Their position is shown in the illustration on the cover page and in *Figure 1 on page 3*.

Table 1. Pin description

Symbol	Туре	Function
Out	Analog output	The Out voltage is proportional to the magnitude of the sense voltage $V_p\text{-}V_m$ .
Gnd		Ground line
Vcc+	Power supply	Positive power supply line.
Vcc-		Negative power supply line.
Vp	Analog input	Connection for the external sense resistor. The measured current enters the shunt on the $\rm V_{\rm p}$ side.
Vm	Analog input	Connection for the external sense resistor. The measured current exits the shunt on the $V_{\rm m}$ side.
SEL1	Digital input	Cain coloct nin
SEL2	Digital input	Gain-select pin



## 2 Absolute maximum ratings and operating conditions

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>id</sub>	Input pins differential voltage (V <sub>p</sub> -V <sub>m</sub> )	±20	
V <sub>in_sense</sub>	Sensing pins input voltages (V <sub>p</sub> , V <sub>m</sub> ) <sup>(1)</sup>	-16 to 75	
V <sub>in_sel</sub>	Gain selection pins input voltages (SEL1, SEL2) <sup>(2)</sup>	-0.3 to V <sub>cc+</sub> +0.3	V
V <sub>cc+</sub>	Positive supply voltage <sup>(2)</sup>	-0.3 to 7	V
V <sub>CC+</sub> -V <sub>CC-</sub>	DC supply voltage	0 to 15	
V <sub>out</sub>	DC output pin voltage <sup>(2)</sup>	-0.3 to V <sub>cc+</sub> +0.3	
T <sub>stg</sub>	Storage temperature	-55 to 150	°C
T <sub>j</sub>	Maximum junction temperature	150	O
В	TSSOP8 thermal resistance junction to ambient	120	°C/W
R <sub>thja</sub>	SO8 thermal resistance junction to ambient	125	C/VV
	HBM: human body model <sup>(3)</sup>	2.5	kV
ESD	MM: machine model <sup>(4)</sup>	150	V
	CDM: charged device model <sup>(5)</sup>	1.5	kV

- 1. These voltage values are measured with respect to the  $V_{\text{cc-}}$  pin.
- 2. These voltage values are measured with respect to the Gnd pin.
- Human body model: a 100 pF capacitor is charged to the specified voltage, then discharged through a 1.5 kΩ resistor between two pins of the device. This is done for all couples of connected pin combinations while the other pins are floating.
- 4. Machine model: a 200 pF capacitor is charged to the specified voltage, then discharged directly between two pins of the device with no external series resistor (internal resistor < 5 Ω). This is done for all couples of connected pin combinations while the other pins are floating.
- Charged device model: all pins plus package are charged together to the specified voltage and then discharged directly to ground.

Table 3. Operating conditions

Symbol	Parameter	Value	Unit
V <sub>cc+</sub>	Supply voltage in single-supply configuration from $T_{min}$ to $T_{max}$ ( $V_{cc-}$ connected to Gnd = 0 V)	2.7 to 5.5	V
	Negative supply voltage in dual-supply configuration from T <sub>min</sub> to T <sub>max</sub>	-	
V <sub>cc-</sub>	V <sub>cc+</sub> = 5.5 V max	-8 to 0	V
	V <sub>cc+</sub> = 3 V max	-11 to 0	
V <sub>icm</sub>	Common-mode voltage range referred to pin Vcc - $(T_{min} \text{ to } T_{max})$	2.9 to 70	V
T <sub>oper</sub>	Operational temperature range (T <sub>min</sub> to T <sub>max</sub> )	-40 to 125	°C



### 3 Electrical characteristics

The electrical characteristics given in the following tables are measured under the following test conditions unless otherwise specified.

- $T_{amb}$  = 25 °C,  $V_{cc+}$  = 5 V,  $V_{cc-}$  connected to Gnd (single-supply configuration).
- $V_{\text{sense}} = V_p V_m = 50 \text{ mV}$ ,  $V_m = 12 \text{ V}$ , no load on Out, all gain configurations.

#### Table 4. Supply

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>CC</sub>	Total supply current	V <sub>sense</sub> = 0 V, T <sub>min</sub> < T <sub>amb</sub> < T <sub>max</sub>		200	360	
I <sub>CC1</sub>	Total supply current	$V_{\text{sense}}$ = 50 mV Av = 50 V/V $T_{\text{min}}$ < $T_{\text{max}}$	-	300	480	μA

#### Table 5. Input

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
DC CMR	DC common-mode rejection Variation of V <sub>out</sub> versus V <sub>icm</sub> referred to input <sup>(1)</sup>	2.9 V< V <sub>m</sub> < 70 V T <sub>min</sub> < T <sub>amb</sub> < T <sub>max</sub>	90	105		
AC CMR	AC common-mode rejection Variation of V <sub>out</sub> versus V <sub>icm</sub> referred to input (peak-to-peak voltage variation)	Av = 50 V/V or 100 V/V 2.9 V< $V_m$ < 30 V 1 kHz sine wave		95		dB
SVR	Supply voltage rejection Variation of $V_{out}$ versus $V_{CC}^{(2)}$ SEL1 = Gnd, SEL2 = Gnd	$2.7 \text{ V} < \text{V}_{\text{CC}} < 5.5 \text{ V}$ $\text{V}_{\text{sense}} = 30 \text{ mV}$ $\text{T}_{\text{min}} < \text{T}_{\text{amb}} < \text{T}_{\text{max}}$	85	95		
V <sub>os</sub>	Input offset voltage <sup>(3)</sup>	$T_{amb}$ = 25 °C $T_{min}$ < $T_{amb}$ < $T_{max}$			±500 ±1100	μV
dV <sub>os</sub> /dT	Input offset drift vs. T	$AV = 50 \text{ V/V}$ $T_{min} < T_{amb} < T_{max}$	-20		+5	μV/°C
I <sub>lk</sub>	Input leakage current	$V_{CC} = 0 V$ $T_{min} < T_{amb} < T_{max}$			1	μΑ
I <sub>ib</sub>	Input bias current	$V_{\text{sense}} = 0 \text{ V}$ $T_{\text{min}} < T_{\text{amb}} < T_{\text{max}}$		10	15	μ
V <sub>IL</sub>	Logic low voltage threshold (SEL1 and SEL2)	$V_{CCmin} < V_{CC} < V_{CCmax}$ $T_{min} < T_{amb} < T_{max}$	-0.3		0.5	V
V <sub>IH</sub>	Logic high voltage threshold $V_{CCmin} < V_{CC} < V_{CCmax}$ (SEL1 and SEL2) $T_{min} < T_{amb} < T_{max}$ 1.2			V <sub>CC</sub>	V	
I <sub>sel</sub>	Gain-select pins (SEL1 and SEL2) input bias current	SEL pin connected to GND or $V_{CC}$ $T_{min}$ < $T_{amb}$ < $T_{max}$		400		nA

- 1. See Section 5: Parameter definitions for the definition of CMR.
- 2. See Section 5 for the definition of SVR.
- 3. See Section 5 for the definition of  $V_{os}$ .



Electrical characteristics TSC103

Table 6. Output

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Av	Gain	SEL1 = Gnd, SEL2 = Gnd SEL1 = Gnd, SEL2 = Vcc+ SEL1 = Vcc+, SEL2 = Gnd SEL1 = Vcc+, SEL2 = Vcc+		20 25 50 100		V/V
ΔV <sub>out</sub> /ΔT	Output voltage drift vs. T <sup>(1)</sup>	$Av = 50 \text{ V/V}$ $T_{min} < T_{amb} < T_{max}$			±240	ppm/°C
$\Delta V_{out} / \Delta I_{out}$	Output stage load regulation	-10 mA < I <sub>out</sub> <10 mA I <sub>out</sub> sink or source current Av = 50 V/V		0.3	±1.5	mV/mA
$\Delta V_{out}$	Total output voltage accuracy <sup>(2)</sup>	$V_{\text{sense}}$ = 50 mV <sup>(3)</sup> $T_{\text{amb}}$ = 25 ° C $T_{\text{min}}$ < $T_{\text{amb}}$ < $T_{\text{max}}$			±2.5 ±4	
$\Delta V_{out}$	Total output voltage accuracy	$V_{sense}$ = 90 mV <sup>(3)</sup> $T_{amb}$ = 25 ° C $T_{min}$ < $T_{amb}$ < $T_{max}$			±3.5 ±5	
$\Delta V_{out}$	Total output voltage accuracy	$V_{sense}$ = 20 mV $T_{amb}$ = 25 ° C $T_{min}$ < $T_{amb}$ < $T_{max}$			±3.5 ±5	%
$\Delta V_{out}$	Total output voltage accuracy	$V_{sense}$ = 10 mV $T_{amb}$ = 25 ° C $T_{min}$ < $T_{amb}$ < $T_{max}$			±5.5 ±8	
$\Delta V_{out}$	Total output voltage accuracy	$V_{sense}$ = 5 mV $T_{amb}$ = 25 ° C $T_{min}$ < $T_{amb}$ < $T_{max}$			±10 ±22	
I <sub>sc</sub>	Short-circuit current	OUT connected to V <sub>CC</sub> or GND	15	26		mA
V <sub>OH</sub>	Output stage high-state saturation voltage V <sub>OH</sub> = V <sub>CC</sub> -V <sub>out</sub>	V <sub>sense</sub> = 1 V I <sub>out</sub> = 1 mA		85	135	mV
V <sub>OL</sub>	Output stage low-state saturation voltage	V <sub>sense</sub> =-1 V I <sub>out</sub> = 1 mA		80	125	

<sup>1.</sup> See Section 5: Parameter definitions for the definition of output voltage drift versus temperature.

<sup>2.</sup> Output voltage accuracy is the difference with the expected theoretical output voltage V<sub>out-th</sub>=Av\*V<sub>sense</sub>. See Section 5 for a more detailed definition.

<sup>3.</sup> Except for Av = 100 V/V.

### Table 7. Frequency response

Symbol	Parameter	Parameter Test conditions		Тур.	Max.	Unit
	Response to input differential	V <sub>sense</sub> square pulse applied to generate a variation of Vout from 500 mV to 3 V C <sub>load</sub> = 47 pF		-		μs
ts	voltage change.	Av = 20 V/V,	-	3	-	
	Output settling to 1% of final value	Av = 25 V/V		4	-	
		Av = 50 V/V		6		
		Av = 100 V/V		10		
t <sub>SEL</sub>	Response to a gain change. Output settling to 1% of final value	Any change of state of SEL1 or SEL2 pin		1		
t <sub>rec</sub>	Response to common-mode voltage change. Output settling to 1% of final value	$V_{cc+}$ = 5 V, $V_{cc-}$ = -5 V $V_m$ step change from -2 V to 30 V or 30 V to -2 V	-	20	-	μs
SR	Slew rate	V <sub>sense</sub> = 10 mV to 100 mV	0.4	0.6	-	V/µs
BW	3 dB bandwidth	$C_{load}$ = 47 pF $V_m$ = 12 V $V_{sense}$ = 50 mV Av = 50 V/V	-	700	-	kHz

#### Table 8. Noise

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
e <sub>N</sub>	Equivalent input noise voltage	f = 1 kHz	-	40	-	nV/√Hz



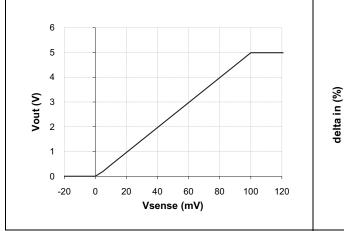
### 4 Electrical characteristics curves: current sense amplifier

Unless otherwise specified, the test conditions for the following curves are:

- Tamb = 25 °C, V<sub>CC</sub> = 5 V, Vsense = Vp Vm = 50 mV, Vm = 12 V
- No load on Out pin

Figure 4. Output voltage vs. Vsense

Figure 5. Output voltage accuracy vs. Vsense



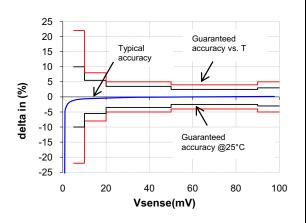


Figure 6. Supply current vs. supply voltage

350 300 250 200 T = 25 °C T = 125 °C T = 125 °C Vcc (V)

Figure 7. Supply current vs. Vsense

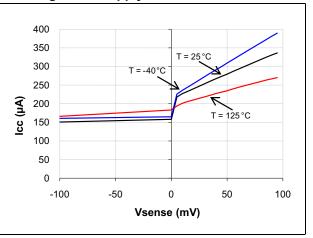
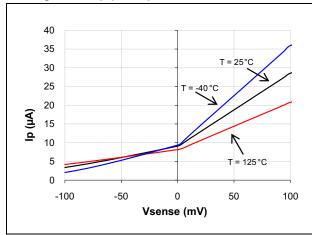


Figure 8. Vp pin input current vs. Vsense

Figure 9. Vn pin input current vs. Vsense



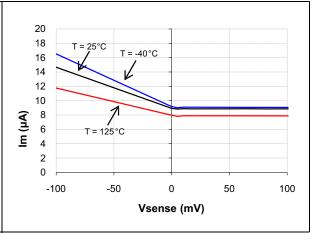
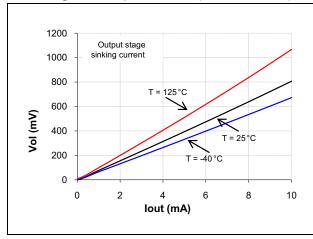


Figure 10. Output stage low-state saturation voltage vs. output current (Vsense = -1 V)

Figure 11. Output stage high-state saturation voltage vs. output current (Vsense = +1 V)



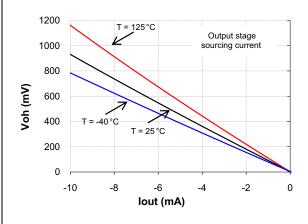
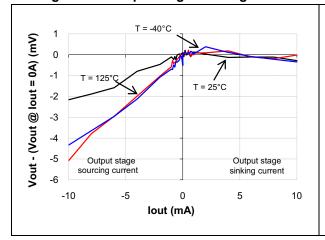
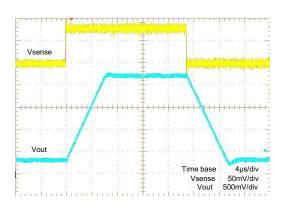


Figure 12. Output stage load regulation

Figure 13. Step response

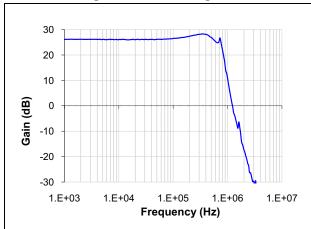




577

Figure 14. Bode diagram

Figure 15. Power supply rejection ratio



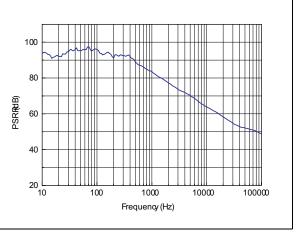
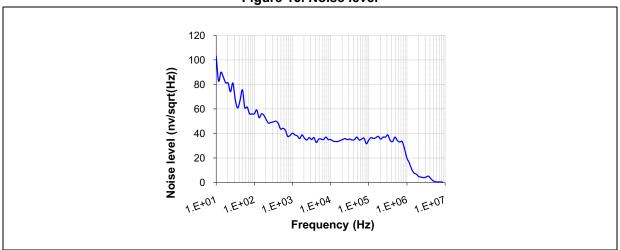


Figure 16. Noise level



577

TSC103 Parameter definitions

#### 5 Parameter definitions

#### 5.1 Common-mode rejection ratio (CMR)

The common-mode rejection ratio (CMR) measures the ability of the current-sensing amplifier to reject any DC voltage applied on both inputs  $V_p$  and  $V_m$ . The CMR is referred back to the input so that its effect can be compared with the applied differential signal. The CMR is defined by the formula:

$$CMR = -20 \cdot log \frac{\Delta V_{out}}{\Delta V_{icm} \cdot Av}$$

#### 5.2 Supply voltage rejection ratio (SVR)

The supply-voltage rejection ratio (SVR) measures the ability of the current-sensing amplifier to reject any variation of the supply voltage  $V_{CC}$ . The SVR is referred back to the input so that its effect can be compared with the applied differential signal. The SVR is defined by the formula:

$$SVR = -20 \cdot log \frac{\Delta V_{out}}{\Delta V_{CC} \cdot Av}$$

### 5.3 Gain (Av) and input offset voltage (V<sub>os</sub>)

The input offset voltage is defined as the intersection between the linear regression of the  $V_{out}$  vs.  $V_{sense}$  curve with the X-axis (see *Figure 17*). If  $V_{out1}$  is the output voltage with  $V_{sense} = V_{sense2}$ , then  $V_{os}$  can be calculated with the following formula.

$$V_{os} = V_{sense1} - \left( \frac{V_{sense1} - V_{sense2}}{V_{out1} - V_{out2}} \cdot V_{out1} \right)$$



Parameter definitions TSC103

Vout\_1

Vout\_2

Vos Vsense2 Vsense1

AM04520

Figure 17.  $V_{out}$  versus  $V_{sense}$  characteristics: detail for low  $V_{sense}$  values

The values of  $V_{sense1}$  and  $V_{sense2}$  used for the input offset calculations are detailed in *Table 9*.

Table 9. Test conditions for  $V_{os}$  voltage calculation

Av (V/V)	V <sub>sense1</sub> (mV)	V <sub>sense2</sub> (mV)
20	50	5
25	50	5
50	50	5
100	40	5

TSC103 Parameter definitions

#### 5.4 Output voltage drift versus temperature

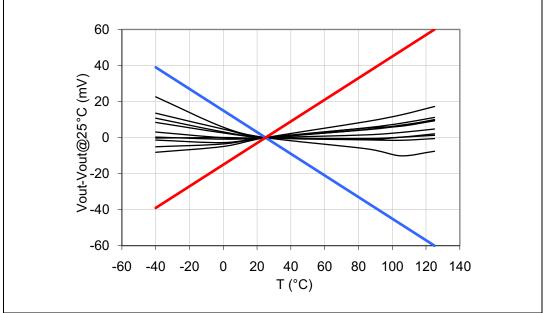
The output voltage drift versus temperature is defined as the maximum variation of  $V_{out}$  with respect to its value at 25 °C over the temperature range. It is calculated as follows:

$$\frac{\Delta V_{out}}{\Delta T} = max \frac{V_{out}(T_{amb}) - V_{out}(25^{\circ}C)}{T_{amb} - 25^{\circ}C}$$

with  $T_{min} < T_{amb} < T_{max}$ .

*Figure 18* provides a graphical definition of the output voltage drift versus temperature. On this chart,  $V_{out}$  is always within the area defined by the maximum and minimum variation of  $V_{out}$  versus T, and T = 25 °C is considered to be the reference.





Parameter definitions TSC103

#### 5.5 Input offset drift versus temperature

The input voltage drift versus temperature is defined as the maximum variation of  $V_{os}$  with respect to its value at 25 °C over the temperature range. It is calculated as follows:

$$\frac{\Delta V_{os}}{\Delta T} = max \frac{V_{os}(T_{amb}) - V_{os}(25^{\circ}C)}{T_{amb} - 25^{\circ}C}$$

with  $T_{min} < T_{amb} < T_{max}$ .

*Figure 19* provides a graphical definition of the input offset drift versus temperature. On this chart,  $V_{os}$  is always within the area defined by the maximum and minimum variation of  $V_{os}$  versus T, and T = 25 °C is considered to be the reference.

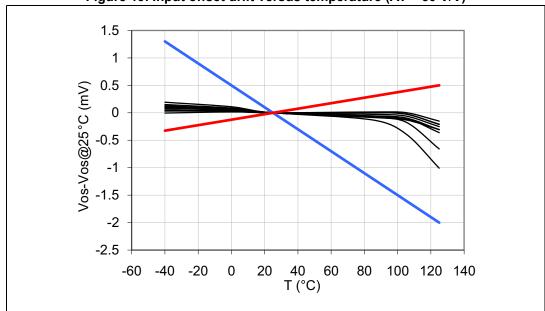


Figure 19. Input offset drift versus temperature (Av = 50 V/V)

### 5.6 Output voltage accuracy

The output voltage accuracy is the difference between the actual output voltage and the theoretical output voltage. Ideally, the current sensing output voltage should be equal to the input differential voltage multiplied by the theoretical gain, as in the following formula.

$$V_{out-th} = Av.V_{sense}$$

The actual value is very slightly different, mainly due to the effects of:

- the input offset voltage V<sub>os</sub>
- the non-linearity

**577** 

TSC103 Parameter definitions

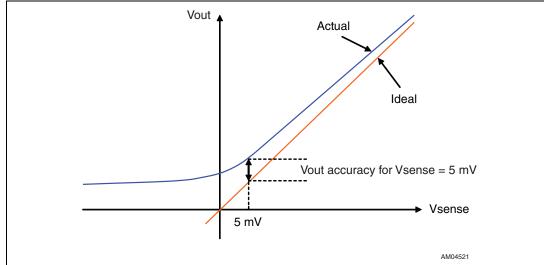


Figure 20.  $V_{out}$  vs.  $V_{sense}$  theoretical and actual characteristics

The output voltage accuracy, expressed as a percentage, can be calculated with the following formula,

$$\Delta V_{out} = \frac{abs(V_{out}^{-}(Av \cdot V_{sense}))}{Av \cdot V_{sense}}$$

with 20 V/V, 25 V/V, 50 V/V or 100 V/V depending on the configuration of the SEL1 and SEL2 pins.

## 6 Maximum permissible voltages on pins

The TSC103 can be used in either a single or dual supply configuration. The dual-supply configuration is achieved by disconnecting Vcc- and Gnd, and connecting Vcc- to a negative supply. *Figure 21* illustrates how the absolute maximum voltages on input pins Vp and Vm are referred to the Vcc- potential, while the maximum voltages on the positive supply pin, gain selection pins, and output pins are referred to the Gnd pin. It should also be noted that the maximum voltage between Vcc- and Vcc+ is limited to 15 V.

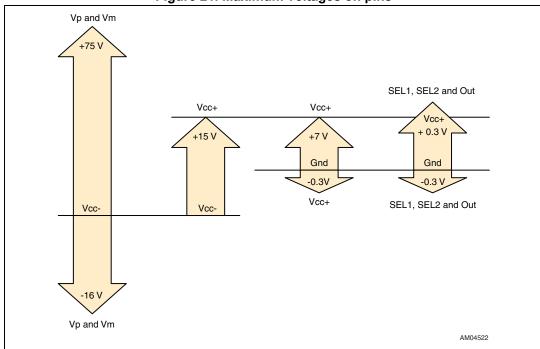


Figure 21. Maximum voltages on pins

577

### 7 Application information

The TSC103 can be used to measure current and to feed back the information to a microcontroller.

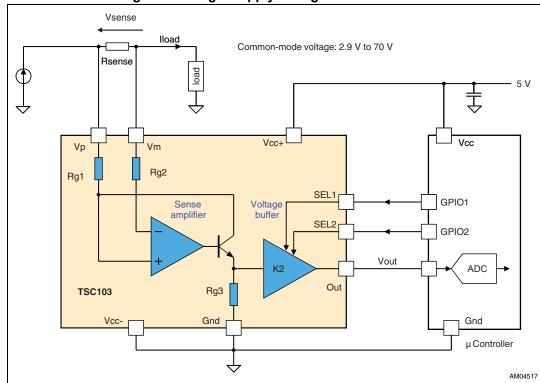


Figure 22. Single-supply configuration schematic

The current from the supply flows to the load through the  $R_{sense}$  resistor, causing a voltage drop equal to  $V_{sense}$  across  $R_{sense}$ . The amplifier's input currents are negligible, therefore its inverting input voltage is equal to  $V_m$ . The amplifier's open-loop gain forces its non-inverting input to the same voltage as the inverting input. Consequently, the amplifier adjusts the current flowing through  $R_{\alpha 1}$  so that the voltage drop across  $R_{\alpha 1}$  matches  $V_{sense}$  exactly.

Therefore, the drop across R<sub>q1</sub> is:

$$V_{Rg1} = V_{sense} = R_{sense} I_{load}$$

If  $I_{Ra1}$  is the current flowing through  $R_{a1}$ , then  $I_{Ra1}$  is given by the formula:

$$I_{Rg1} = V_{sense}/R_{g1}$$

The  $I_{Rg1}$  current flows entirely into resistor  $R_{g3}$  (the input bias current of the buffer is negligible). Therefore, the voltage drop on the  $R_{g3}$  resistor can be calculated as follows.

$$V_{Rg3} = R_{g3}.I_{Rg1} = (R_{g3}/R_{g1}).V_{sense} = K1.V_{sense}$$
 with K1=R<sub>g3</sub>/R<sub>g1</sub>.

The voltage across the  $R_{g3}$  resistor is buffered to the Out pin by the voltage buffer, featuring a gain equal to K2. Therefore  $V_{out}$  can be expressed as:

$$V_{out} = K1.K2.V_{sense} = Av.V_{sense}$$
 with Av= K1.K2



DocID16873 Rev 3

19/25

The resistor ratio, K1 =  $R_{g3}/R_{g1}$ , is internally set to 20 V/V, and the voltage buffer gain, K2, can be set to 1, 1.25, 2.5, or 5 depending on the voltage applied on the SEL1 and SEL2 pins. Since they define the full-scale output range of the application, the  $R_{sense}$  resistor and the amplification gain Av are important parameters and must therefore be selected carefully.

577

TSC103 Package information

# 8 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK<sup>®</sup> is an ST trademark.



DocID16873 Rev 3 21/25

Package information TSC103

# 8.1 TSSOP8 package information

O.25 mm GAGE PLANE

Figure 23. TSSOP8 package mechanical drawing

Table 10. TSSOP8 package mechanical data

			Dimer	nsions			
Ref.		Millimeters			Inches		
	Min.	Тур.	Max.	Min.	Тур.	Max.	
Α			1.20			0.047	
A1	0.05		0.15	0.002		0.006	
A2	0.80	1.00	1.05	0.031	0.039	0.041	
b	0.19		0.30	0.007		0.012	
С	0.09		0.20	0.004		0.008	
D	2.90	3.00	3.10	0.114	0.118	0.122	
E	6.20	6.40	6.60	0.244	0.252	0.260	
E1	4.30	4.40	4.50	0.169	0.173	0.177	
е		0.65			0.0256		
k	0°		8°	0°		8°	
L	0.45	0.60	0.75	0.018	0.024	0.030	
L1		1			0.039		
aaa			0.10			0.004	

47/

TSC103 Package information

# 8.2 SO8 package information

D hx45'

SEATING PLANE

GAGE PLANE

1 e 4

Figure 24. SO8 package mechanical drawing

Table 11. SO8 package mechanical data

			Dime	nsions			
Ref.		Millimeters			Inches		
	Min.	Тур.	Max.	Min.	Тур.	Max.	
Α			1.75			0.069	
A1	0.10		0.25	0.004		0.010	
A2	1.25			0.049			
b	0.28		0.48	0.011		0.019	
С	0.17		0.23	0.007		0.010	
D	4.80	4.90	5.00	0.189	0.193	0.197	
Е	5.80	6.00	6.20	0.228	0.236	0.244	
E1	3.80	3.90	4.00	0.150	0.154	0.157	
е		1.27			0.050		
h	0.25		0.50	0.010		0.020	
L	0.40		1.27	0.016		0.050	
L1		1.04			0.040		
k	0		8°	1°		8°	
ccc			0.10			0.004	



Ordering information TSC103

# 9 Ordering information

Table 12. Order codes

Part number	Temperature range	Package	Packaging	Marking
TSC103IPT	40° C +125 °C	TSSOP8	Tape and reel	1031
TSC103IDT	-40° C, +125 °C	SO8		TSC103I
TSC103IYPT <sup>(1)</sup>	-40° C, +125 °C	TSSOP8		103Y
TSC103IYDT <sup>(1)</sup>	automotive grade	SO8		TSC103Y

Qualification and characterization according to AEC Q100 and Q003 or equivalent, advanced screening according to AEC Q001 & Q002 or equivalent.

# 10 Revision history

Table 13. Document revision history

Date	Revision	Changes	
04-Jan-2010	1	Initial release.	
18-Nov-2011	2	Added Chapter 4: Electrical characteristics curves: current sense amplifier. Changed Figure 4 to Figure 16. Added automotive grade qualification for SO8 package in Table 12: Order codes.	
31-Jan-2014	3	Table 12: Updated automotive-grade footnotes	

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